Features and Benefits

- The control circuit and the LED share the only power source.
- Control circuit and RGB chip are integrated in a package of 5050 components, to form a complete addressable pixel.
- Built-in signal reshaping circuit, after wave reshaping to the next driver, ensure wave-form distortion not accumulate.
- Built-in electric reset circuit and power lost reset circuit.
- Each pixel of the three primary color can achieve 256 brightness display, completed 16777216 color full color display,
- Port scanning frequency is of 2KHz.Data receiving and decoding can be completed through a signal line.
- When the refresh rate is 30fps, cascade quantity are not less than 1024 pixels.
- Data transmission speed up to 800Kbps.
- The color of the light is highly consistent, cost-effective..
- With power reverse protection function,Power reverse connection won't damage led.
- No need any electronic components including capacitor for the PCB design.

Applications

- Consumer electronics.
- LED decorative lighting,
- Computer and peripheral equipment, game equipment, various electrical equipment field.

General description

WS2812B-V5/W is a intelligent control LED light source that the control circuit and RGB chip are integrated in a package of 5050 components.It internal include intelligent digital port data latch and signal reshaping amplification drive circuit.Also include a precision internal oscillator and a voltage programmable constant current control part, effectively ensuring the pixel point light color height consistent.

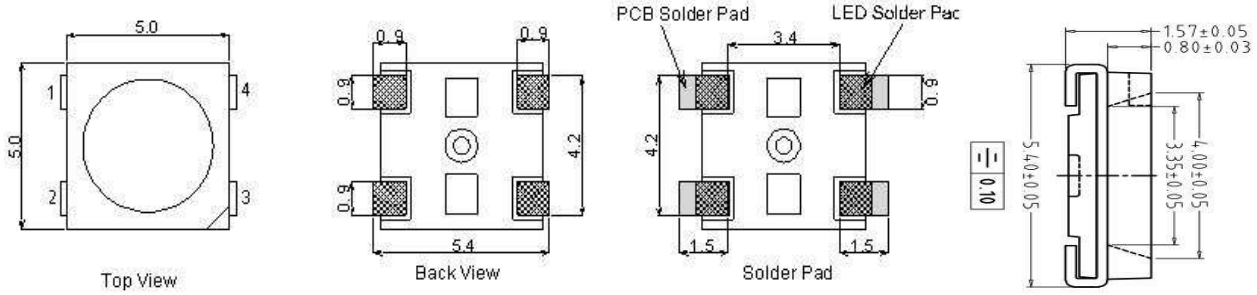
The data transfer protocol use single NZR communication mode. After the pixel power-on reset, the DIN port receive data from controller, the first pixel collect initial 24bit data then sent to the internal data latch, the other data which reshaping by the internal signal reshaping amplification circuit sent to the next cascade pixel through the DO port. After transmission for each pixel, the signal to reduce 24bit. pixel adopt auto reshaping transmit technology, making the pixel cascade number is not limited the signal transmission, only depend on the speed of signal transmission.

RESET time>**280μs** , it won't cause wrong reset while interruption, it supports the lower frequency and inexpensive MCU.

Refresh Frequency updates to **2KHz**, Low Frame Frequency and No Flicker appear in HD Video Camera, it improve excellent display effect.

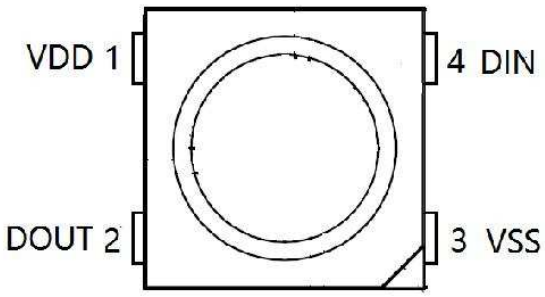
LED with low driving voltage, environmental protection and energy saving, high brightness, scattering angle is large, good consistency, low power, long life and other advantages. The control chip integrated in LED above becoming more simple circuit, small volume, convenient installation.

Mechanical Dimensions



Remarks: Dimension of 5.0*5.4*1.57mm, default Tolerance of 0.05mm.

PIN Configuration



PIN Function

NO.	Symbol	PIN	Function description
1	VDD	POWER SUPPLY	Power supply
2	DOUT	DATA OUT	Control data signal output
3	VSS	GROUND	Ground,data & power grounding
4	DIN	DATA IN	Control data signal input

Absolute Maximum Ratings（T_A=25℃,V_{SS}=0V）

Parameter	Symbol	Ratings	Unit
Power supply voltage	V_{DD}	+3.7~+5.3	V
Logical Input Voltage	V_I	**-0.3V～VDD+0.7V**	V

Electrical Characteristics（T_A=25℃, V_{DD}=5V, V_{SS}=0V）

Parameter	Symbol	Min	Tpy	Max	Unit	Conditions
Input current	I_I	——	——	±1	μA	V_I=V_{DD}/V_{SS}
High Voltage Input	V_{IH}	0.63VDD	——	VDD+0.7V	V	D_{IN}，SET
Low Voltage Input	V_{IL}	-0.3V	——	0.7V	V	D_{IN}，SET

Switching Characteristics（T_A=25℃, V_{DD}=5V, V_{SS}=0V）

Parameter	Symbol	Min	Tpy	Max	Unit	Condition
Transmission delay time	t_{PLZ}	——	——	300	ns	CL=15pF, DIN→DOUT,RL=10KΩ
Fall time	t_{THZ}	——	——	120	μs	CL=300pF, OUTR/OUTG/OUTB
Input capacity	C_I	——	——	15	pF	——

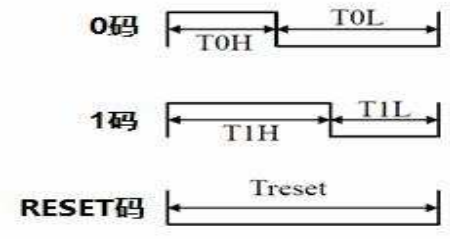
LED Characteristics（T_A=25℃，V_{DD}=5V，V_{SS}=0V）

Parameter	Symbol	Color	Quiescent Current: 0.6mA				Condition (Working current)
			Mini	Typ	Max	Unit	
Brightness	IV	Red	300	310	500	mcd	12mA
		Green	600	780	1000		
		Blue	200	215	300		
Wavelength	λd	Red	620	621	630	nm	12mA
		Green	515	520	525		
		Blue	465	471	475		

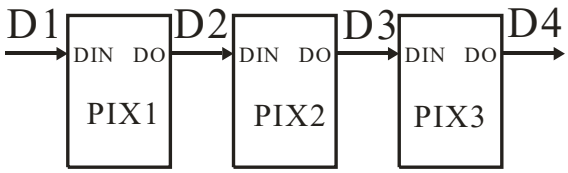
Data Transfer Time

T0H	0 code, high voltage time	220ns~380ns
T1H	1 code, high voltage time	580ns~1μs
T0L	0 code, low voltage time	580ns~1μs
T1L	1 code, low voltage time	**580ns~1μs**
RES	Frame unit, low voltage time	>280μs

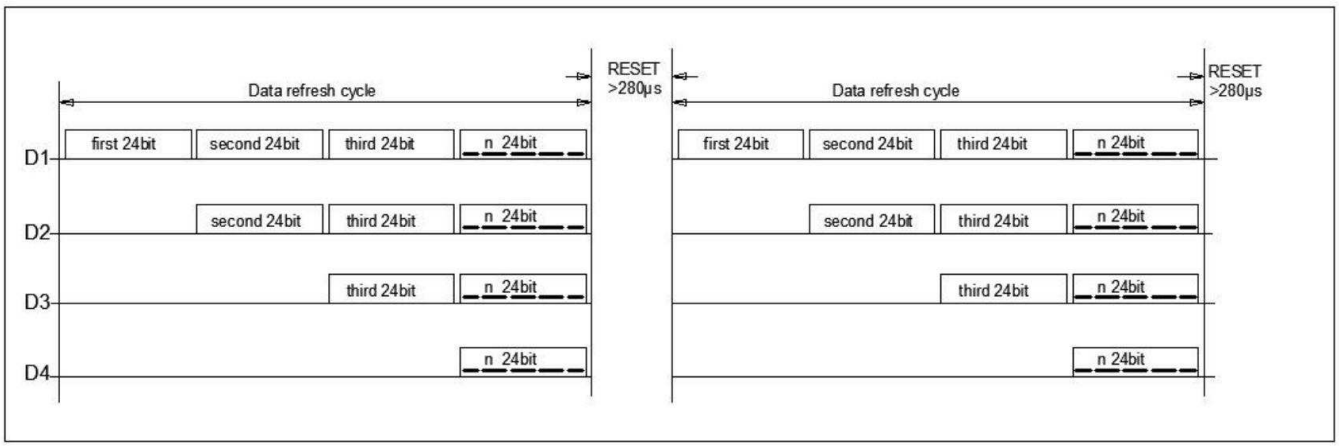
Sequence Chart



Cascade Method



Data Transmission Method



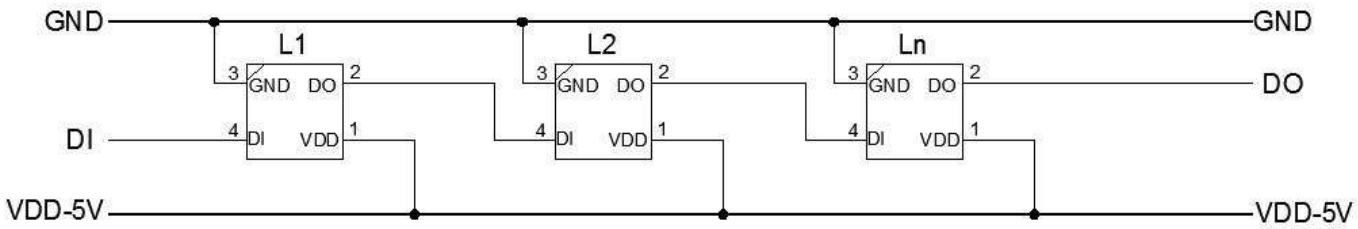
Note: The data of D1 is send by MCU, and D2, D3, D4 through pixel internal reshaping amplification to transmit.

Composition of 24bit Data

G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4	R3	R2	R1	R0	B7	B6	B5	B4	B3	B2	B1	B0

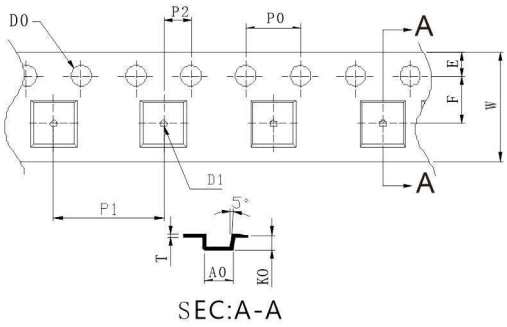
Note: Data transmit in order of GRB, high bit data at first.

Typical Application Circuit: The peripheral circuit don't need to add filter capacitor.

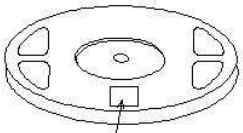


Packing Standard

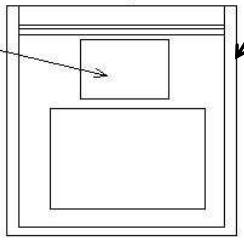
Packing: 1K/Reel: 167*12mm
4.5K/Reel: 327*12mm

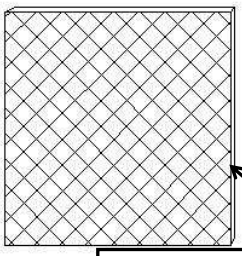


Carrier tape	
SYMBOL	SPEC
W	12.00±0.20
T	0.25±0.02
A0	5.35±0.10
B0	5.75±0.10
K0	1.85±0.10
E	1.75±0.10
F	5.50±0.10
D0	1.60±0.10
D1	1.60±0.10
P1	8.00±0.10
P2	2.00±0.05
10*P0	40.00±0.20



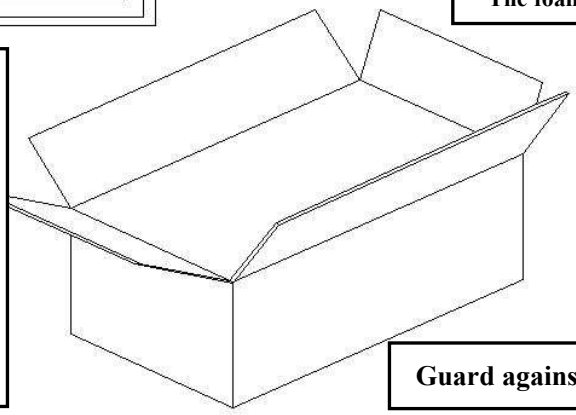
Anti-static bag





Product Label

The foam protective layer



Guard against damp/ Keep dry

Worldsemi Top SMD LED Using Instructions

1. Summary

To make the best use of WORLDSEMI's LED, please refer to the below precautions, they are of same usage method as other electronic components.

2. Cautions

2.1. Dust & Cleaning

The surface of the LED is encapsulated with modified epoxy resin because it plays a very good role in protecting the optical performance and aging resistance. The modified epoxy resin is easy to stick with dust and must be kept clean. When there's a certain amount of dust on the surface of the LED, it won't affect brightness, but dust proof should be taken care of. Promoting the use of unsealed package in preference to others and the assembled LEDs should be placed in a clean container. Avoid using the organic solvents to clean the dust on the LED surface and it's necessary to confirm whether the cleaning fluid will dissolve the LED.Do not clean the LEDs by the ultrasonic. Some parameters affecting the LED performance must be evaluated if have no alternative but to the ultrasonic cleaning method, such as ultrasonic power, baking time and assembly conditions, etc.

2.2. Moisture-proof packaging

TOP SMD LEDs are moisture sensitive components. LEDs are packaged in aluminum foil bag to prevent the LED from absorbing moisture during transport and storage. desiccant is placed in the bags to absorb moisture. If the LED absorbs moisture, then it evaporates and expands when in reflow process, which may break the colloid from the bracket and damage the optical performance of LED. For this reason, moisture-proof packaging is to prevent the from absorbing moisture during transport and storage. But usually the protection time can only maintain 1 ~ 2 months. During SMT, please refer to the definition of material moisture-proof Grade (MSL) stipulated by IPC/JEDECJ-STD-020 for MSL control. The moisture resistance rating of WORLDSEMI's LED is: **LEVEL 5a.**

Tabel I - IPC/JEDEC J-STD-020 Moisture/Reflow Sensitivity Classification

MSL Level	Workshop Life	
	Time	Conditions
LEVEL1	Unlimited	≤30°C/85%RH
LEVEL2	1 Year	≤30°C/60%RH
LEVEL2a	4 Weeks	≤30°C/60%RH
LEVEL3	168 Hours	≤30°C/60%RH
LEVEL4	72 Hours	≤30°C160%RH
LEVEL5	48 Hours	≤30°C/60%RH
LEVEL5a	**24 Hours**	**≤30°C/60%RH**
LEVEL6	Take-out and Use immediately	≤30°C/60%RH

2.3 SMT Instruction:

2.3.1 It is recommended that opening the Vacuum plastic bag before SMT, and put the whole reel into the oven for dehumidification and drying (Bake at 70 ~ 75℃ ≧24H);

2.3.2 From the led taken out of the oven to the completion of high temperature welding (including multiple reflow welding, tin immersion, wave soldering, heating maintenance and other high temperature operations/operations), the time period shall be controlled within 24Hours (Under condition of T<30℃, RH<60%);

2.3.3 After the LED paste is printed on the PCBA, SMT process should be completed as soon as possible, it is recommended not to exceed 1H;

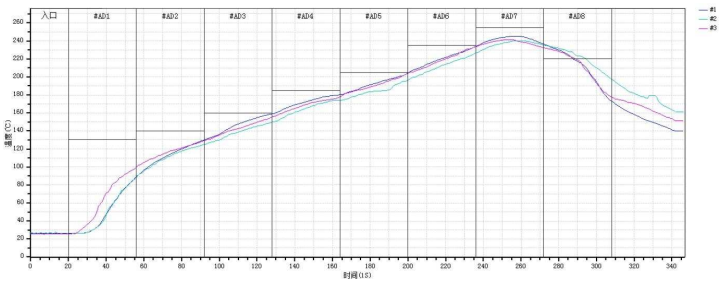
2.3.4 Bulk material LED, such as production surplus, machine material, maintenance material, can not be used directly if exposed to the air for a long time. It is recommended to be dehumidified and dried before being used.

Whole reel baking: 70 ~ 75℃* ≧24H or bulk led baking: 120℃*4H.

3. SMT Reflow Soldering

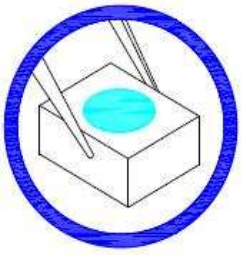
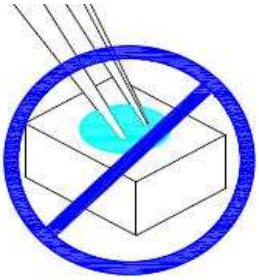
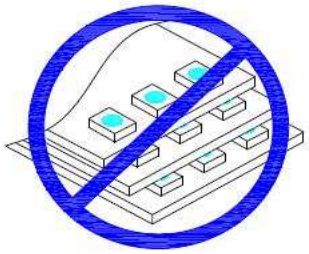
Refer to the parameters listed below, the experimental results prove that the TOP SMD LED meets the JEDEC J-STD-020C standards. As a general guideline, it is recommended to follow the SMT reflow temperature curve recommended by the solder paste manufacturer.

Curve Description	Lead-free
30℃ ~ 150℃ preheating slope	1～4 ℃/s
30℃ ~ 150℃ preheating time	60～120 s
150℃ to 200℃ constant temperature slope	0～3 ℃/s
150℃ ~ 200℃ constant temperature time	60～120 s
LIQUID REGION temperature (TL)	217℃
Peak Temperature (Tp)	245℃
Reflow slopeTime (tp)	0～3 ℃/s
Reflow soldering time	45-90 s
Cooling Rate	-4～0 ℃/s
Room Temperature to Peak Holding Time	<6 min



Remarks: 1. All the above temperatures refer to the temperatures measured on the surface of the package body

4. Assembly Precautions

1. Clip the LED from its side.	2. Neither directly touch the gel surface with the hand or sharp instrument, it may damage its internal circuit.	3. Not to be double stacked, it may damage its internal circuit.	4. Can not be stored in or applied in the acidic sites of PH<7.
			

Modify Record

Version №	Status Bar	Modify Content Summary	Date	Reviser	Approved
V1.0	N	New	20170523	Shen JInGuo	Yin Huaping
V1.1	M	Maximum rating	20171009	Shen JInGuo	Yin Huaping
V1.2	M	Maximum rating, transmission time	20180207	Shen JInGuo	Yin Huaping
V2.0	M	Electric Parameter	20180412	Shen JInGuo	Yin Huaping
V3.0	M	Notes section	20180719	Shen JInGuo	Yin Huaping
V4.0	M	Logic input voltage;Brightness calibration	20180822	Shen JInGuo	Yin Huaping
V5.0	M	IC upgrade,Power reverse connection will not be damaged,no need any components include capacitor	20190323	Shen JInGuo	Yin Huaping
V5.1	M	Notes for product installation process; SMT instruction	20200722	Shen JInGuo	Yin Huaping
V6.0	M	The glue changed to mist, P/N is changed to WS2812B-V5/W	2021/12/2	Yu XingHui	Yin Huaping

Remarks: Initial version: V1.0； Version number plus "0.1" after each revision;

Status bar: N--New, A--Add, M--Modify, D--Delete.

1. Version number plus "0.1" if for add & modify parameters, eg. V1.0→ V1.1
2. Major revision or many parameters modified, version number plus “1.0”, eg. V1.0→ V2.0
3. No version number is attached to Part Number